## CBCS SCHEME

USN			18ME743
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## Seventh Semester B.E. Degree Examination, Dec.2024/Jan.2025 **Additive Manufacturing**

Max. Marks: 100 Time: 3 hrs.

	N	ote: Answer any FIVE full questions, choosing ONE full question from each mo	dule.
		Module-1	
1	a.	Define Additive Manufacturing. List out advantages and disadvantages in detail.	(10 Mark
	b.	Explain with a neat diagram the process chain of additive manufacturing.	(10 Mark
		OR	
2	a.	What are the eight steps in manufacturing? Explain briefly.	(10 Mark
	b.	What are the distinction between AM and CNC machining?	(06 Mark
	c.	Explain milestones in AM development.	(04 Mark
		Module-2	
3	a.	Explain molten materials system for FDM in AM with a neat diagram.	(10 Mark
	b.	Explain the following with a neat sketch:	
		(i) Bio-Extrusion (ii) Electron Beam melting.	(10 Mark
		OR	
4	a.	Explain with the help of neat diagram Sterolithography (SL).	(10 Mark
	b.	What are the applications of photo polymerization processes?	(04 Mark
	c.	Explain with neat sketch, Selective Laser Sintering (SLS).	(06 Mark
		200-4/1-2	
_		Module-3  Final single law in standard in construction and process with a post sketch	(10 Mark
5	a.	Explain the laminated object manufacturing process with a neat sketch.	(10 Mark (10 Mark
	b.	Explain the Ultrasonic Consolidation (UC) with a neat sketch.	(IU Maik
		GOV OR	
_	_	Explain with help of neat diagram general beam deposition process.	(10 Mark
6	a. h	Explain the following with a neat sketch:	(10 Main
	0. /	(i) Ink based direct write (ii) Laser transfer (iii) Direct write thermal pray	(10 Mark
		(i) his based direct write (ii) Easer dansler (iii) Errore write are man proj	(
		Module-4	
7	a.	Explain the following:	
,	u.	(i) Selection methods for sport (ii) Production planning and control	(10 Mark
	b.	Explain the STL file, problems with STL files and STL file manipulation.	(10 Mark
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		OR	
8	a.	Explain various steps involved in preparation for use as a pattern.	(06 Mark
	b.	Explain surface texture improvement.	(04 Mark
	c.	Explain the property enhancements using non thermal techniques and thermal techniques	iniques.

- c. Explain the property enhancements using non thermal techniques and thermal techniques. (10 Marks)

## Module-5

- 9 Explain the following:
  - (i) Multiple material approaches
  - (ii) Discrete multiple material processes

(12 Marks)

(iii) Porous multiple material processes. b. Write any eight applications of AM in aerospace, medical, automobile and general (08 Marks) engineering.

- Explain the following: 10
  - (i) Functional models
  - (ii) Engineering analysis model

(iii) New materials development. (12 Marks)

b. Define direct digital manufacturing and explain align technology and DDM drivers.

(08 Marks)